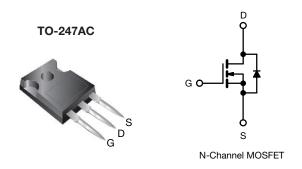


**Vishay Siliconix** 

# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.061			
Q <sub>g</sub> max. (nC)	189				
Q <sub>gs</sub> (nC)	26				
Q <sub>gd</sub> (nC)	55				
Configuration	Single				

### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG47N60AEF-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_{\rm C}$	$= 25 ^{\circ}\text{C}, \text{unit}$	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	40		
	VGS at 10 V	T <sub>C</sub> = 100 °C		25	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	111		
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	508	mJ	
Maximum power dissipation			PD	313	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C			70		
Reverse diode dv/dt <sup>d</sup>		dv/dt	50	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6.0 A

c. 1.6 mm from case

d.  $I_{SD}$  = 23.5 A, di/dt = 250 A/µs, starting  $T_J$  = 25  $^\circ\text{C}$ 

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	40	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.4	0/1	

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1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92033



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PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT
Static		-					
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 10 mA		0.72	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA		-	4	V
		,	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{\rm GS} = \pm 30  \rm V$	-	-	± 1	μA
Zara gata valtaga drain overant	1	V <sub>DS</sub> =	480 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2	mA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	l <sub>D</sub> = 23.5 A	-	0.061	0.070	Ω
Forward transconductance <sup>a</sup>	<b>g</b> fs	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 23.5 A		-	13	-	S
Dynamic		•					
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,		-	3576	-	pF
Output capacitance	Coss	,	$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		167	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	104	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	535	-	
Total gate charge	Qg			-	126	189	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{GS} = 10 \text{ V}$ $I_D = 23.5 \text{ A}, V_{DS} = 480 \text{ V}$		26	-	nC
Gate-drain charge	Q <sub>gd</sub>				55	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 23.5 A,		-	35	70	- ns
Rise time	t <sub>r</sub>			-	63	126	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		143	286	
Fall time	t <sub>f</sub>	1 1		-	67	134	
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	s	-			-		
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I <sub>SM</sub>			-	-	111	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 23.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 23.5 A,		-	160	320	ns
Reverse recovery charge	Q <sub>rr</sub>			-	1.2	2.4	μC
Reverse recovery current	I <sub>BBM</sub>	ai/at = 1	di/dt = 100 A/µs, V <sub>R</sub> = 400 V		14.3	-	A

Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 





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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

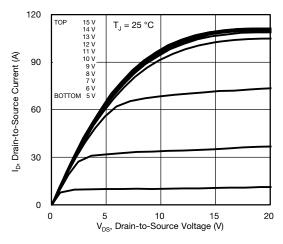
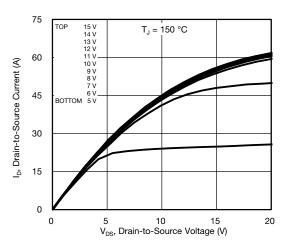
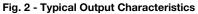


Fig. 1 - Typical Output Characteristics





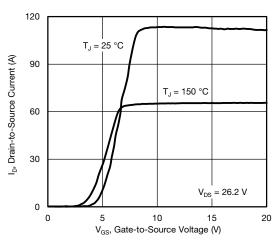


Fig. 3 - Typical Transfer Characteristics

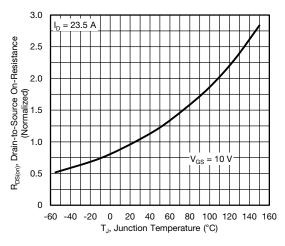


Fig. 4 - Normalized On-Resistance vs. Temperature

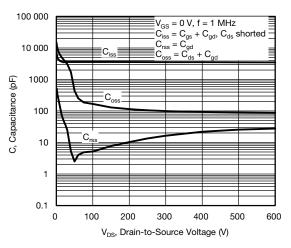


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

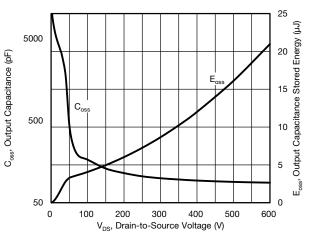


Fig. 6 - C<sub>oss</sub> and E<sub>oss</sub> vs. V<sub>DS</sub>

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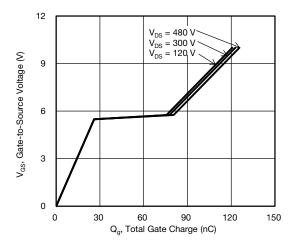


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

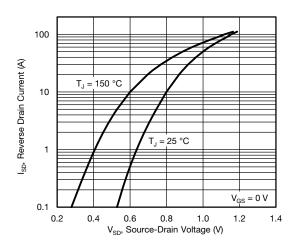
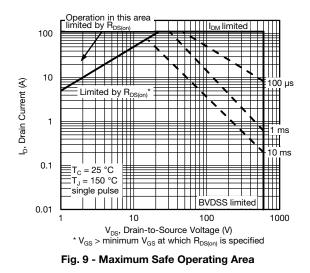


Fig. 8 - Typical Source-Drain Diode Forward Voltage



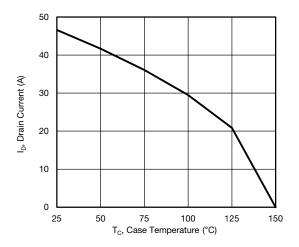


Fig. 10 - Maximum Drain Current vs. Case Temperature

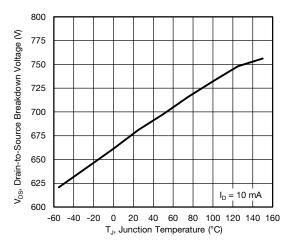


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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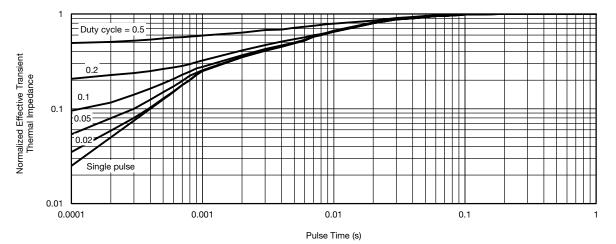


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

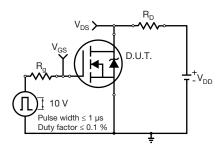


Fig. 13 - Switching Time Test Circuit

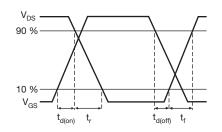


Fig. 14 - Switching Time Waveforms

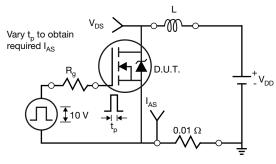


Fig. 15 - Unclamped Inductive Test Circuit

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 $V_{DD}$  $V_{\rm DS}$  $I_{AS}$ 

Fig. 16 - Unclamped Inductive Waveforms

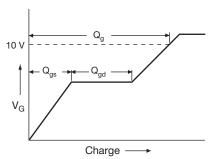


Fig. 17 - Basic Gate Charge Waveform

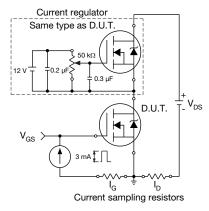
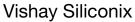


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

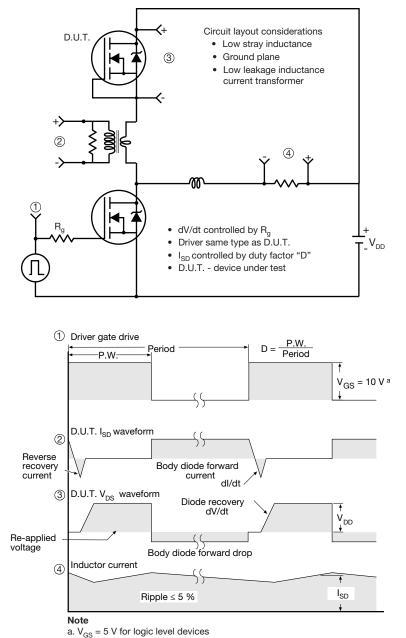


Fig. 19 - For N-Channel

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